

RoHS Compliant Product

A suffix of "-C" specifies halogen & lead-free

FEATURES

- For Surface Mounted Applications
- Low Profile Package
- Glass Passivated Chip Junction
- Super Fast Reverse Recovery Time
- Lead Free in Comply with EU RoHS 2011/65/EU Directives

MECHANICAL DATA

- Case: Molded Plastic SMB
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color Band Denotes Cathode End

MARKING

Part Number	Marking Code	Part Number	Marking Code
SUF301BR-C	ES3A	SUF304BR-C	ES3G
SUF302BR-C	ES3B	SUF305BR-C	ES3J
SUF303BR-C	ES3D		

PACKAGE INFORMATION

Package	MPQ	Leader Size
SMB	3K	13 inch

ORDER INFORMATION

Part Number	Type
SUF301BR-C~SUF305BR-C	Lead (Pb)-free and Halogen-free

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.

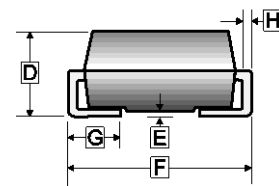
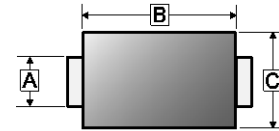
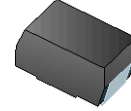
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number					Unit
		SUF301BR-C	SUF302BR-C	SUF303BR-C	SUF304BR-C	SUF305BR-C	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	
Maximum Average Forward Rectified Current @ $T_C=100^\circ\text{C}$	I_F	3					A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	90					A
Maximum Instantaneous Forward Voltage @ $I_F=3\text{A}$	V_F	1		1.25	1.68		V
Maximum DC Reverse Current @ Rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	5					μA
	$T_A=125^\circ\text{C}$	100					
Typical Junction Capacitance ²	C_J	45					pF
Maximum Reverse Recovery Time ¹	T_{rr}	35					nS
Typical Thermal Resistance ³	$R_{\theta JA}$	50					$^\circ\text{C/W}$
	$R_{\theta JC}$	16					
Operating & Storage Temperature Range	T_J, T_{STG}	-55~150					$^\circ\text{C}$

Notes:

1. Measured with $I_F=0.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=0.25\text{A}$.
2. Measured at 1MHz and applied reverse voltage of 4V D.C.
3. P.C.B. mounted with 2.0" x 2.0" (5 x 5 cm) copper pad areas.

SMB

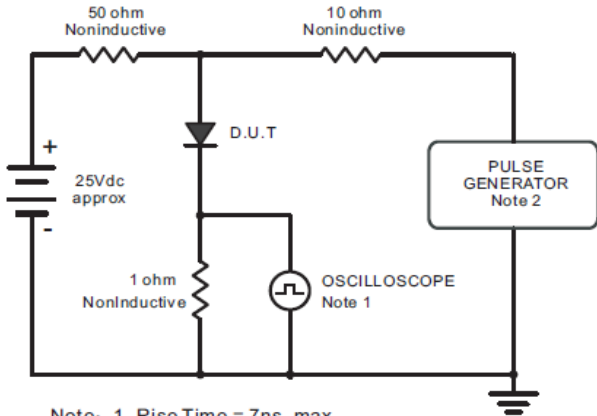


REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	1.85	2.20	E	-	0.25
B	4.00	4.85	F	5.05	5.59
C	3.25	3.94	G	0.75	1.55
D	1.90	2.61	H	0.15	0.31

Cathode  Anode 

RATINGS AND CHARACTERISTIC CURVES

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rises Time = 10ns, max.
Source Impedance = 50 ohms.

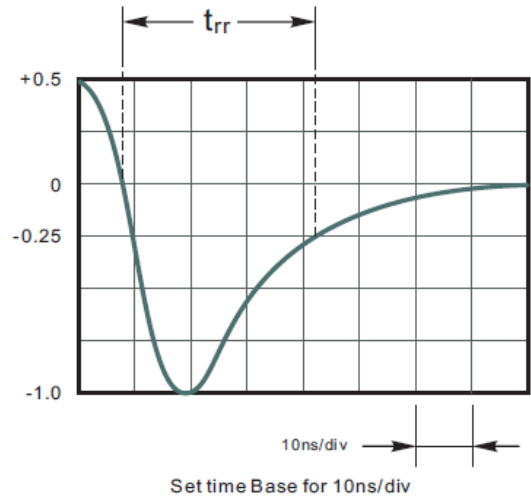


Fig.2 Maximum Average Forward Current Rating

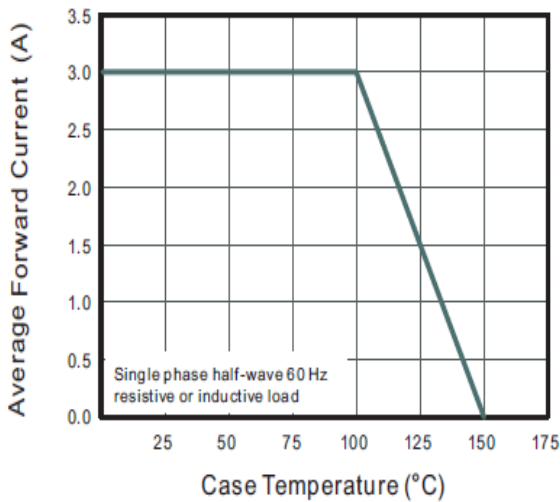


Fig.3 Typical Reverse Characteristics

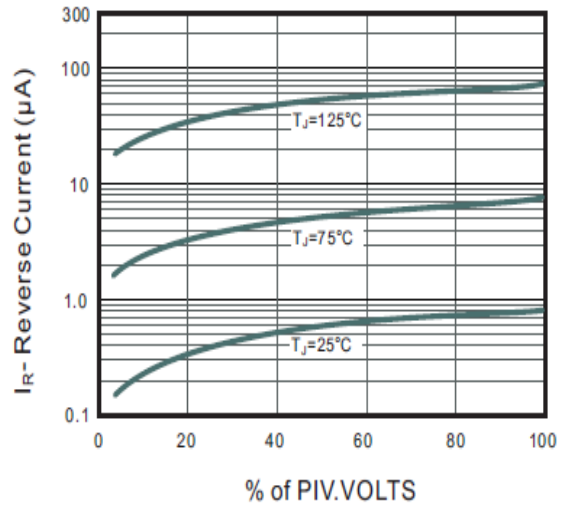


Fig.4 Typical Forward Characteristics

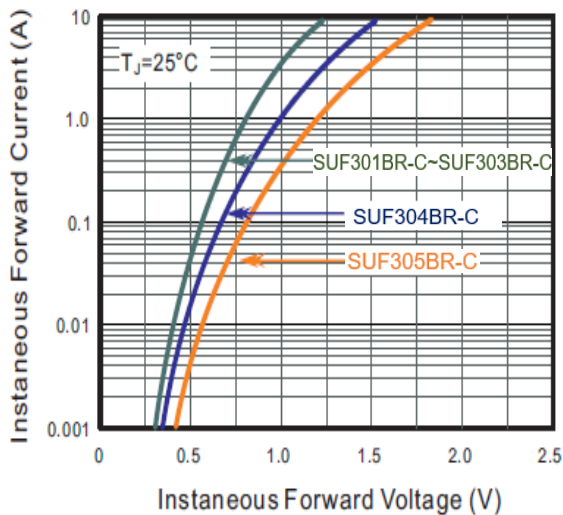
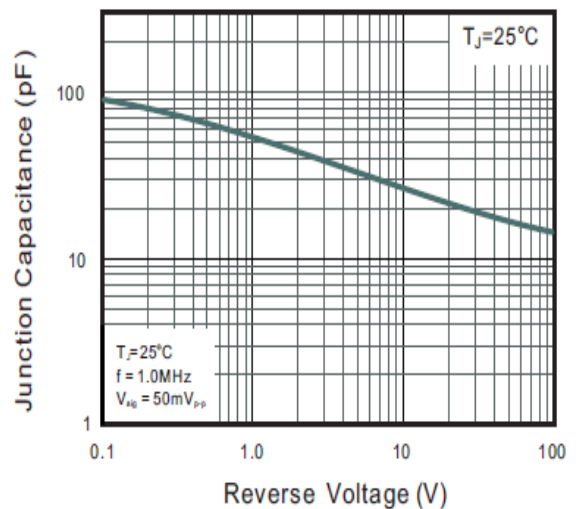


Fig.5 Typical Junction Capacitance



RATINGS AND CHARACTERISTIC CURVES

Fig.6 Maximum Non-Repetitive Peak Forward Surge Current

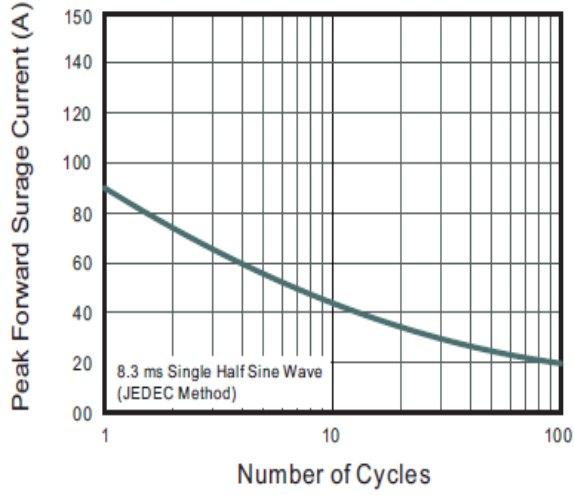


Fig.7 Mounting Pad Layout

